ME476C: Senior Design Project Status Report: November 15, 2004

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Problem Statement:

• Orbital requires a low profile electronics packaging design that will accommodate the specified printed wiring board (PWB) outline, and number of specified modules.

Top Issues:

- State of the Art search: More state of the art research has been done on the electronics packaging related companies suggested by Orbital. SOTA research has also been done on analysis and modeling methods, allowing for a more specified explanation of methodology in the proposal.
- Proposal Document: The proposal document is nearly completed, and will be submitted to Orbital pending instructor review and corrections. The goal is to deliver the proposal document to Orbital before the planned Thursday, November

18 meeting. This way Orbital may have a chance to look it over and provide feedback in the teleconference.

- Proposal Presentation: As part of the proposal document, the proposal presentation is to be completed soon. A first cut has been finished, but further assignment requirements from instructor are needed to finalize the presentation.
- Brainstorming and initial design development will begin immediately after submittal of the proposal for approval.

Decisions Pending:

• Proposal Approval: After the proposal is submitted to Orbital, the decision of acceptance of proposal terms will be the main decision of this semester. Feedback from Orbital and any suggested changes will be fully considered and discussed at the November 18 meeting.